onsemi

Integrated Load Switch FDC6330L

Description

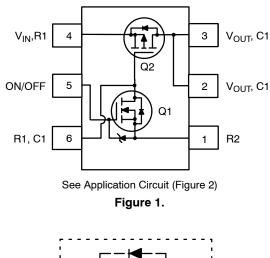
This device is particularly suited for compact power management in portable electronic equipment where 3 V to 20 V input and 2.3 A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SUPERSOTTM -6 package.

Features

- $V_{DROP} = 0.20 \text{ V} @ V_{IN} = 12 \text{ V}, I_L = 2.5 \text{ A}, R_{(on)} = 0.08 \Omega$
- $V_{DROP} = 0.20 \text{ V} @ V_{IN} = 5 \text{ V}, I_L = 1.6 \text{ A}, R_{(on)} = 0.125 \Omega$
- Control MOSFET (Q1) Includes Zener Protection for ESD Ruggedness (> 6 kV Human Body Model)
- High Performance POWERTRENCH[®] Technology for Extremely Low On–Resistance
- SUPERSOT-6 Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- This is a Pb-Free and Halide Free Device

Application

- Power Management
- Load Actuation



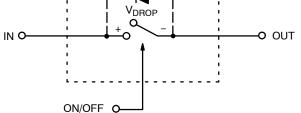


Figure 2. Equivalent Circuit

© Semiconductor Components Industries, LLC, 1999 December, 2021 – Rev. 3



TSOT-23-6 CASE 419BL

MARKING DIAGRAM



= Designates Space

- = Binary Calendar Year Coding Scheme
- = Pin One Dot

&E

&Y

&.

&G

330 = Specific Device Code

= Date Code

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------|------------------------|-----------------------|
| FDC6330L | TSOT-23-6 (Pb-Free) | 3000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FDC6330L

ABSOLUTE MAXIMUM RATINGS T_A = 25°C unless otherwise noted

| Symbol | Parameter | Value | Unit |
|-----------------------------------|---|------------|------|
| V _{IN} | Input Voltage Range (Note 1) | 3 – 20 | V |
| V _{ON/OFF} | On/Off Voltage Range | 1.5 – 8 | V |
| I _D | Load Current – Continuous (Note 2) | 2.3 | А |
| | Load Current – Pulsed | 10 | |
| PD | Maximum Power Dissipation (Note 1) | 0.7 | W |
| T _J , T _{STG} | Operating and Storage Temperature Range | -55 to 150 | °C |
| ESD | Electrostatic Discharge Rating MIL–STD–883D Human Body Model (100 pF / 1500 $\Omega)$ | 6 | kV |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

| Symbol | Symbol Parameter | | Unit |
|-----------------|--|-----|------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (Note 2) | 180 | °C/W |
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case (Note 2) | 60 | °C/W |

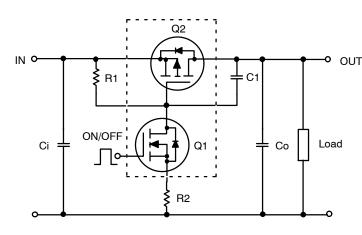
ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------------------|--|-----|-------|-------|------|
| OFF CHARAC | TERISTICS | | | | | |
| I _{FL} | Leakage Current | V _{IN} = 20 V, V _{ON/OFF} = 0 V | - | - | 1 | μA |
| ON CHARAC | TERISTICS (Note 3) | | | | | |
| V _{DROP} | Conduction Voltage | V_{IN} = 12 V, $V_{ON/OFF}$ = 3.3 V, I_L = 2.5 A | - | - | 0.2 | V |
| | | $V_{IN} = 5 \text{ V}, V_{ON/OFF} = 3.3 \text{V}, \text{I}_{L} = 1.6 \text{A}$ | - | - | 0.2 | |
| R _{DS(on)} | Q ₂ – Static On–Resistance | $V_{GS} = -12 \text{ V}, \text{ I}_{D} = -2.3 \text{ A}$ | - | 0.054 | 0.08 | Ω |
| | | $V_{GS} = -5 \text{ V}, \text{ I}_{D} = -1.9 \text{ A}$ | - | 0.081 | 0.125 | |
| ١L | Load Current | $V_{DROP} = 0.2 \text{ V}, V_{IN} = 12 \text{ V}, V_{ON/OFF} = 3.3 \text{ V}$ | 2.5 | - | - | А |
| | | V_{DROP} = 0.2 V, V_{IN} = 5 V, $V_{ON/OFF}$ = 3.3 V | 1.6 | - | - | |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

- 1. Range of V_{in} can be up to 30 V, but R_1 and R_2 must be scaled such that V_{GS} of Q2 does not exceed 20 V. 2. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.



External Component Recommendation:

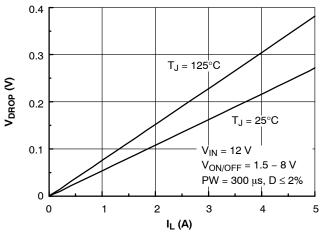
For applications where Co \leq 1 μ F. For slew rate control, select R2 in the range of $1k - 4.7 k\Omega$. For additional in-rush current control, $C1 \leq 1000 \text{ pF}$ can be added.

Select R1 so that the R1/R2 ratio ranges from 10-100. R1 is required to turn Q2 off.



FDC6330L

TYPICAL CHARACTERISTICS





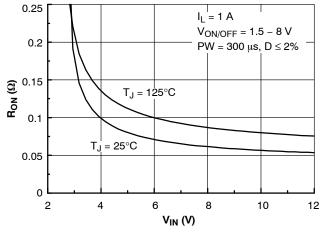


Figure 6. On-Resistance Variation with Input Voltage

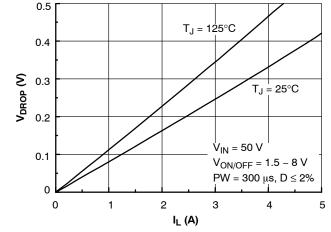


Figure 5. Conduction Voltage Drop Variation with Load Current

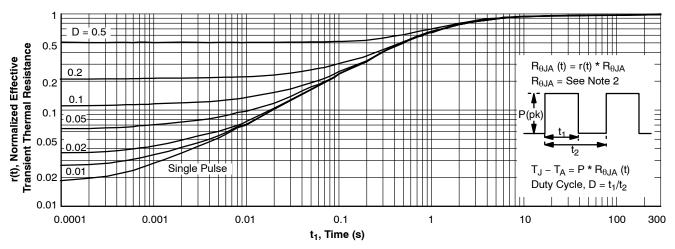
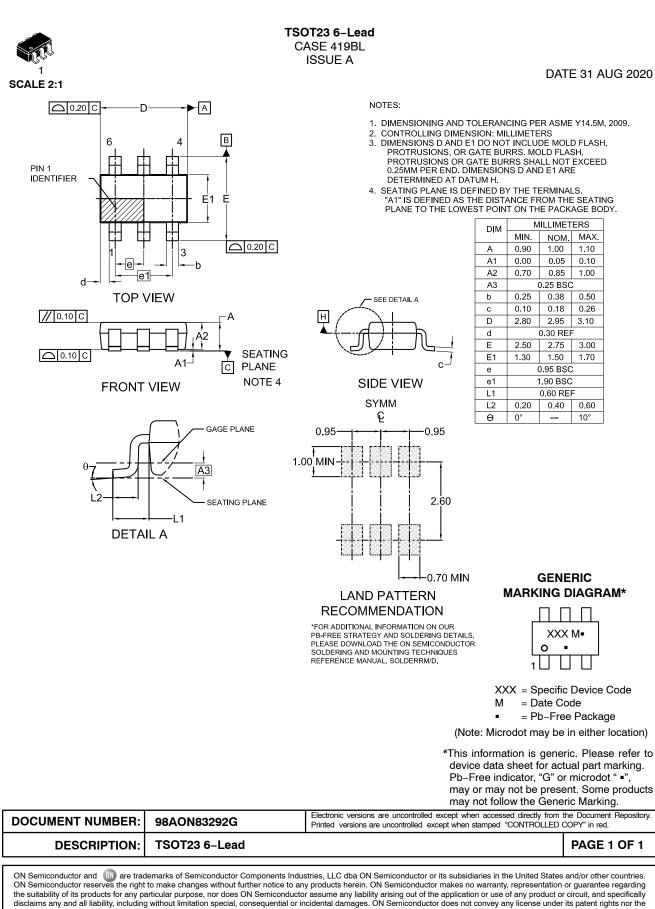


Figure 7. Transient Thermal Response Curve

NOTE: Thermal characterization performed on the conditions described in Note 2. Transient thermal response will change depending on the circuit board design.

SUPERSOT is a trademark and POWERTRENCH is a registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.





rights of others

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

٥